



# **ALPHA DATA**

## **ADM-XRC-7V1 User Manual**

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**Head Office**

**Address:** Suite L4A, 160 Dundee Street,  
Edinburgh, EH11 1DQ, UK  
**Telephone:** +44 131 558 2600  
**Fax:** +44 131 558 2700  
**email:** sales@alpha-data.com  
**website:** <http://www.alpha-data.com>

**US Office**

611 Corporate Circle, Suite H  
Golden, CO 80401  
(303) 954 8768  
(866) 820 9956 - toll free  
sales@alpha-data.com  
<http://www.alpha-data.com>

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# 1 Introduction

The **ADM-XRC-7V1** is a high-performance XMC for applications using Virtex-7 and Virtex-6 FPGAs from Xilinx. This card supports all Virtex-7 devices available in the FF(G), FH(G), and FL(G), 1761 package.

The **ADM-XRC-7V1** includes separate FPGA with a PCIe bridge developed by Alpha Data. Using a separate device allows high performance operation without the need to integrate proprietary cores in the user (target) FPGA.

With the release of 7series FPGA boards, Alpha Data has introduced a new build option to allow the mezzanine card to be assembled without the bridge to reduce power and cost.

The **ADM-XRC-7V1** is available in air-cooled and conduction-cooled configurations. View the ADM-XRC-7V1 Ordering Info tab at [ADM-XRC-7V1 Product Page](#) on [www.alpha-data.com](http://www.alpha-data.com).

## 1.1 Key Features

### Key Features

- Single-width XMC, compliant to VITA Standard 42.0 and 42.3
- Dedicated 4-lane PCI-Express Gen 2 interface with high-performance DMA controllers
- 4 additional PCI-Express compliant GTX links between user FPGA and P5
- Support for Virtex-7 FPGA in FF(G), FH(G), and FL(G)1761 package
- 4 independent banks of DDR3-1600 SDRAM, 256MB/bank, 1GB total (2GB and 4GB option)
- Front-panel (XRM) interface with adjustable voltage, 146 GPIO signals and 8 GTX links to user FPGA
- Rear-panel (XMC) 10 GTX links & 38 GPIO signals between user FPGA and P6
- Rear-panel (PMC) interface with 64 GPIO single ended or differential signals between user FPGA and P4 (optional)
- Rear-Panel I/O (Pn6 and Pn4) compatible with 3U and 6U VPX carriers featuring various VITA 46.9 PMC/XMC to VPX signal mapping configurations
- On-board programmable clocks enabling multiple protocols to be implemented on the user FPGA's high-speed links
- Voltage and temperature monitoring
- Air-cooled and conduction-cooled configurations

## 1.2 References & Specifications

ANSI/VITA 42.0	<i>XMC Standard</i> , December 2008, VITA, ISBN 1-885731-49-3
ANSI/VITA 42.3	<i>XMC PCI Express Protocol Layer Standard</i> , June 2006, VITA, ISBN 1-885731-43-4
ANSI/VITA 46.9	<i>PMC/MXC Rear I/O Fabric Signal Mapping on 3U and 6U VPX Modules Standard</i> , November 2010, VITA, ISBN 1-885731-63-9
ANSI/IEEE 1386-2001	<i>IEEE Standard for a Common Mezzanine Card (CMC) Family</i> , October 2001, IEEE, ISBN 0-7381-2829-5
ANSI/IEEE 1386.1-2001	<i>IEEE Standard Physical and Environmental Layers for PCI Mezzanine Cards (PMC)</i> , October 2001, IEEE, ISBN 0-7381-2831-7
ANSI/VITA 20-2001 (R2005)	<i>Conduction Cooled PMC</i> , February 2005, VITA, ISBN 1-885731-26-4

Table 1 : References

## 2 Installation

### 2.1 Software Installation

Please refer to the Software Development Kit (SDK) installation CD. The SDK contains drivers, examples for host control and FPGA design and comprehensive help on application interfacing.

### 2.2 Hardware Installation

#### 2.2.1 Handling Instructions

The components on this board can be damaged by electrostatic discharge (ESD). To prevent damage, observe ESD precautions:



- Always wear a wrist-strap when handling the card
- Hold the board by the edges
- Avoid touching any components
- Store in ESD safe bag.

#### 2.2.2 Motherboard / Carrier Requirements

The **ADM-XRC-7V1** is a single width XMC.3 mezzanine with optional P6 and P4 connectors. The motherboard/ carrier must comply with the XMC.3 (VITA 42.3) specification for the Primary XMC connector, J5.

The Secondary XMC connector, P6 has a pinout compatible with various XMC to VPX signal maps as defined by VITA 46.9. Please consult the pinouts in this user-guide as-well as those of the carrier manufacturer prior to installation. Assistance can be provided by Alpha Data.

**IMPORTANT**

Connector P6 on the card is not compatible with the VITA 42.10 (XMC GPIO) Standard. In particular, USB VCC must not be applied on this connector.

The **ADM-XRC-7V1** is compatible with either 5V or 12V on the "VPWR" power rail.

##### 2.2.2.1 Installation in ADC-EMC-II Carrier

The Alpha Data ADC-EMC-II carrier accepts both PMC and XMC mezzanine cards. By default, the carrier is configured for PMCs and connects all the serial links from the XMC connector J15 to J25.

To configure for XMC and enable the PCIe interfaces at J15 and J25, switches 1-3 and 1-4 must be ON (closed).

#### 2.2.3 Cooling Requirements

The power dissipation of the board is highly dependent on the Target FPGA application. A power estimator spreadsheet is available on request from Alpha Data. This should be used in conjunction with Xilinx power estimation tools to determine the exact current requirements for each power rail.

The board is supplied with a passive air cooled or conduction cooled heatsink according to the order number given at time of purchase. It is the users responsibility to ensure sufficient airflow for air cooled applications and metalwork for conduction cooled applications.

For more details on heatsinks supplied with Alpha Data boards, please view AD-AN-0018 ADM-XRC Cooling

Solutions.

The board features system monitoring that measures the board and FPGA temperature. It also includes a self-protection mechanism that will clear the target FPGA configuration if an over-temperature condition is detected.

See [Section 3.7](#) for further details.

## 3 Functional Description

### 3.1 Overview

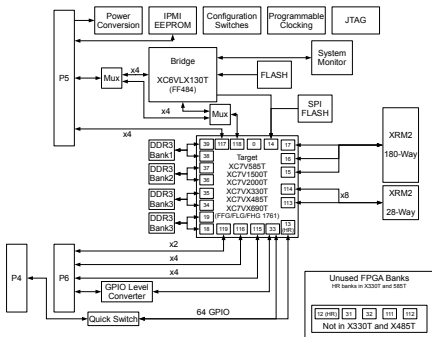


Figure 1 : ADM-XRC-7V1 Block Diagram



### 3.1.1 Switch Definitions

There is a set of eight DIP switches placed on the rear of the board. Their functions are described in [Switch Definitions](#).

**Note:**

All switches are OFF by default. *Factory Configuration* switch must be in the OFF position for normal operation.

Switch Ref.	Function	ON State	Off State
SW1-1	User Switch to Target FPGA	0	1
SW1-2	Reserved	-	Normal Operation
SW1-3	Bridge Bypass	Bridge FPGA is bypassed - PCIe lanes (3:0) are connected directly to the user FPGA.	Bridge FPGA is used. PCIe lanes (3:0) are connected to the bridge.
SW1-4	Flash Boot Inhibit	Target FPGA is not configured from onboard flash memory.	Target FPGA is configured from on-board flash memory.
SW1-5	XMC JTAG	Connect JTAG chain to P5	Isolate JTAG chain from P5
SW1-6	E-Fuse	Enable E-Fuse programming voltage (VccEFuse = 2.5V)	Disable E-Fuse programming voltage (VccEFuse = 0V)
SW1-7	<i>Factory Configuration</i>	-	Normal Operation
SW1-8	Bridge-Less Mode	Bridge-Less Mode Active - User bitstream loaded from SPI flash	PCIe Bridge Mode Active - User bitstream loaded from Bridge

**Table 2 : Switch Definitions**

### 3.1.2 LED Definitions

The position and description of the board status LEDs are shown in [LED Locations](#):

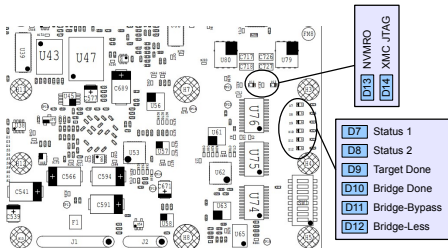


Figure 2 : LED Locations

Comp. Ref.	Function	ON State	Off State
D7(Red)	Status 1	See <a href="#">Status LED Definitions</a>	
D8(Green)	Status 2	See <a href="#">Status LED Definitions</a>	
D9(Green)	Target Done	Target FPGA is configured	Target FPGA is unconfigured
D10(Green)	Bridge Done	Bridge FPGA is configured	Bridge FPGA is unconfigured
D11(Amber)	Bridge Bypass	Bridge FPGA is bypassed - PCIe lanes (3:0) are connected directly to the user FPGA	Bridge FPGA is used. PCIe lanes (3:0) are connected to the bridge.
D12(Amber)	Bridge-Less	Target is configured through Auxiliary SPI memory	Target is configured by Bridge
D13(Amber)	NVMRO	Inhibit writes to non-volatile memories	Enable writes to non-volatile memories
D14(Amber)	XMC JTAG	On-board JTAG chain connected to P5	On-board JTAG chain is isolated from P5

Table 3 : LED Definitions

## 3.2 XMC Platform Interface

### 3.2.1 IPMI I2C

A 4 Kbit I2C EEPROM (type M24C04) is connected to the XMC IPMI. This memory contains board information (type, voltage requirements etc.) as defined in the XMC based specification.

### 3.2.2 MBIST#

Built-In Self Test. This output signal is driven active (low) until the FPGA with PCIe interface is configured. In normal operation, this is the bridge FPGA. In Bridge Bypass mode or Bridge-Less Mode, it is the target FPGA.

### 3.2.3 MVMRO

XMC Write Prohibit. This signal is an input from the carrier. When asserted (high), all writes to non-volatile memories are inhibited. This is indicated by the Amber LED, D13.

This signal cannot be internally driven or over-ridden. A buffered version of the signal is connected to the target FPGA at pin AG32.

### 3.2.4 MRSTI#

XMC Reset In. This signal is an active low input from the carrier. When asserted, the bridge FPGA will be reset.

The MRSTI# signal is translated to 1.8V levels and connected to the target FPGA at pin AF30.

### 3.2.5 MRSTO#

XMC Reset Out. This optional output signal is unused and undriven.

### 3.2.6 MPRESENT#

Module Present. This output signal is connected directly to 0V.

## 3.3 JTAG Interface

### 3.3.1 On-board Interface

A JTAG boundary scan chain is connected to header J1. This allows the connection of the Xilinx JTAG cable for FPGA debug using the Xilinx ChipScope tools.

The JTAG Header pinout is shown in [JTAG Header J1](#):

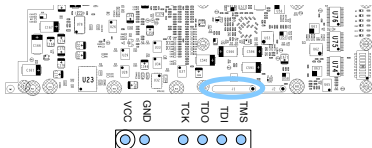


Figure 3 : JTAG Header J1

The scan chain is shown in [JTAG Boundary Scan Chain](#):

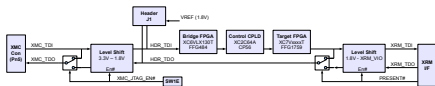


Figure 4 : JTAG Boundary Scan Chain

If the boundary scan chain is connected to the interface at the XMC connector (SW1-5 is ON), Header J1 should not be used.

### 3.3.2 XMC Interface

The JTAG interface on the XMC connector is normally unused and XMC\_TDI connected directly to XMC\_TDO.

The interface can be connected to the on-board interface (through level-translators) by switching SW1-5 ON. See [Switch Definitions](#)

### 3.3.3 JTAG Voltages

The on-board JTAG scan chain uses 1.8V. The Vcc supply provided on J1 to the JTAG cable is +1.8V and is protected by a poly fuse rated at 350mA. 3.3V signals must not be used at header J2.

The JTAG signals at the XMC interface use 3.3V signals and are connected through level translators to the on-board scan chain.

The JTAG signals at the XRM interface use the adjustable voltage XRM\_VIO.

### 3.4 Clocks

The ADM-XRC-7V1 provides a wide variety of clocking options. On top of a fixed 200MHz oscillator and clocks routed from the rear and front panel connectors, the board has 4 user-programmable clocks. These clocks can be combined with the FPGA's internal PLLs to suit a wide variety of communication protocols.

A complete overview of the clock routing on the ADM-XRC-7V1 is given in [Clocks](#). A description of each clock follows.

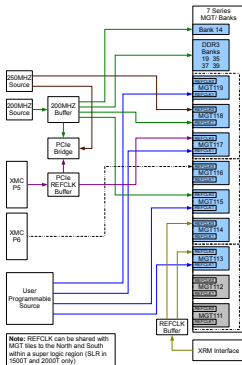


Figure 5 : Clocks

**Note:**

**Clock Termination**

The LVDS clocks do not have termination resistors on the circuit board. On-die terminations in the FPGA must be enabled by setting the attribute "DIFF\_TERM = TRUE". This can either be set in the source code when instantiating the buffer, or in the User Constraints File (UCF). See the Xilinx Virtex-7 Libraries Guide and Constraints Guide for further details.

### 3.4.1 200MHz Reference Clock (REFCLK200M)

The fixed 200MHz reference clock REFCLK200M is a differential clock signal using LVDS. This signal is widely distributed throughout the board.

It is connected to a MRCC inputs on the Target FPGA on Bank 14.

REFCLK200M is also converted to HSTL signaling and used as the input clock for the DRAM interface.

This clock can be used to generate application-specific clock frequencies using the PLLs within the Virtex-7 FPGA. It is also suitable as the reference clock for the IO delay control block (IDELAYCTRL).

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
REFCLK200M	200 MHz	IO_L12_T2_MRCC_14	LVDS	AK34	AL34
REFCLK200M_HSTL	200 MHz	IO_L12_T1_MRCC_19	HSTL_I	L39	L40
REFCLK200M_HSTL	200 MHz	IO_L12_T1_MRCC_35	HSTL_I	E34	E35
REFCLK200M_HSTL	200 MHz	IO_L12_T1_MRCC_37	HSTL_I	D27	D28
REFCLK200M_HSTL	200 MHz	IO_L12_T1_MRCC_39	HSTL_I	H15	H14
REFCLK200M	200 MHz	MGTREFCLK0_115	LVDS	Y8	Y7
REFCLK200M	200 MHz	MGTREFCLK0_118	LVDS	G10	G9

**Table 4 : REFCLK200M Connections**

### 3.4.2 PCIe Reference Clock 0 (PCIEREFCLK0)

The 100MHz PCI Express reference clock is provided by the carrier card through the Primary XMC connector, P5 at pins A19 and B19. This clock is buffered into two PLE Express reference clocks that are forwarded to the Bridge and User FPGA respectively.

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
PCIEREFCLK	100 MHz	MGTREFCLK0_117	LVDS	K8	K7

**Table 5 : PCIEREFCLK Connections**

### 3.4.3 PCIe Reference Clock 1 (PCIEREFCLK1)

The reference clock "PCIEREFCLK1" is a differential clock provided by a carrier card through the Secondary XMC connector P6 at pins A19 and B19. The Default build configuration for this board connects this pair to the MGT signal inputs. Most needed reference clocks can be generated through the User Programmable clocking options. If it is a requirement that this differential pair be utilized as a clock signal to an MGT bank, a resistor fit option is available. Please contact Alpha Data for details.

### 3.4.4 Programmable Clocks (LCLK, PROGCLK 0-3)

There are two programmable clock sources that are forwarded throughout the FPGA. These clocks are programmable through the Alpha Data ADM-XRC Gen 3 SDK. LCLK is generated in the Bridge FPGA by the the Alpha Data ADB3 driver and offers a less accurate frequency resolution, but with a wider programmable frequency range. PROGCLK[3:0] is generated by a dedicated programmable clock generator IC and offer extremely high frequency resolutions (1ppm increments). PROGCLK[3:0] is generated by a single source and buffered to all MGT tiles.

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
LCLK	5 - 700 MHz	IO_L13_MRCC_14	LVDS	AJ32	AK32
PROGCLK0	5 - 312.5 MHz	MGTREFCLK1_113	LVDS	AK8	AK7
PROGCLK1	5 - 312.5 MHz	MGTREFCLK1_115	LVDS	AB8	AB7
PROGCLK2	5 - 312.5 MHz	MGTREFCLK1_117	LVDS	M8	M7
PROGCLK3	5 - 312.5 MHz	MGTREFCLK1_119	LVDS	C10	C9

Table 6 : PROGCLK Connections

### 3.4.5 Module-Carrier Global Clock (GCLK\_M2C)

The clock "GCLK\_M2C" is a differential clock signal using LVDS. It is provided by an XRM module through the XRM connector, CN1, at pins 110 & 108. It is connected to an MRCC input on the Target FPGA.

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
GCLK_M2C	Variable	IO_L13_T2_MRCC_17	LVDS	AF39	AF40

Table 7 : GCLK\_M2C Connections

### 3.4.6 Module-Carrier MGT Clock (MGTCLK\_M2C)

The reference clock "MGTCLK\_M2C" is a differential clock signal using LVDS. The clock is provided by an XRM module through the XRM connector, CN1, at pins 109 & 111. It is first buffered and fanned out, then connected to GTX Quads 113 and 114 on the Target FPGA for application specific frequencies / line rates.

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
MGTCLK_M2C	Variable	MGTREFCLK0_113	LVDS	AH8	AH7
MGTCLK_M2C	Variable	MGTREFCLK0_114	LVDS	AD8	AD7

Table 8 : MGTCLK\_M2C Connections

### 3.4.7 XRM LVDS Clock (XRM\_LVDS\_CLK)

The clock "XRM\_LVDS\_CLK" is a differential clock signal using LVDS levels. The clock is provided by the target FPGA and connected to an XRM module through the XRM connector, CN1, at pins 113 & 115.

Signal	Frequency	Target FPGA Input	IO Standard	"P" pin	"N" pin
XRM_PECL_CLK	Variable	IO_L13_T2_MRCC_15	LVDS	AV40	AW40

**Table 9 : XRM\_LVDS\_CLK Connections**



## 3.5 Flash Memory

A 512Mb Flash Memory (Intel / Numonyx PC28F512P30EF) is used to store board Vital Product Data (VPD), programmable clock parameters and configuration bitstreams for the Bridge and Target FPGAs.

The flash memory cannot be accessed by the target FPGA. Host access is only possible through the FLCTL, FLPAGE and FLDATA registers in the Bridge FPGA.

The region of memory between addresses 0x11000000 and 0x11FFFFFF is allocated for custom data to be stored by the **ADM-XRC-7V1** user.

Utilities for erasing, programming and verification of the flash memory are provided in the ADMXRC SDK.

### Write Protect

The Flash Write Protect (WP#) pin is connected to an inverted version of the NVMRO signal at the XMC interface. When the NVMRO signal is active (High), all writes to the flash will be inhibited. This state will be indicated by the Amber LED as shown in [LED Locations](#).

Alternate Bridge FPGA Bitstream		0x0000_0000
		0x007F_FFFF
Default Bridge FPGA Bitstream		0x0080_0000
		0x00FF_FFFF
Alpha Data Vital Product Data (Alpha Data VPD)		0x0100_0000
		0x010F_FFFF
User Vital Product Data (User VPD)		0x0110_0000
		0x011F_FFFF
B0 Length(7:0)	Boot Flag 0	0x0120_0000
Bitstream 0 Length(23:8)		0x0120_0002
reserved		
Default Target FPGA Bitstream (Target Bitstream 0)		0x0122_0000
		0x028F_FFFF
B1 Length(7:0)	Boot Flag 1	0x0290_0000
Bitstream 1 Length(23:8)		0x0290_0002
reserved		
Alternate Target FPGA Bitstream (Target Bitstream 1)		0x0292_0000
		0x03FF_FFFF

Figure 6 : Flash Memory Map

## 3.6 Configuration

### 3.6.1 Power-Up Sequence

If valid data is stored in the flash memory, the bridge will automatically configure the Target FPGA at power-up.

This sequence can be inhibited by turning the Flash Boot Inhibit (FBI) switch, SW1-4 to ON. (See [Switch Definitions](#)).

**Note:**

If an over-temperature alert is detected from the System Monitor, the target **will be cleared** by pulsing its PROG signal. See [Automatic Temperature Monitoring](#).

### 3.6.2 Bridge-Less Mode

When operating in bridgeless mode, the Target FPGA will be configured directly by a Quad SPI connection to a 1Gb FLASH memory device. This memory device is re-programmable over a Xilinx JTAG cable.

This mode is not available in Revision 2 and earlier boards.

### 3.7 Health Monitoring

The **ADM-XRC-7V1** has the ability to monitor temperature and voltage to maintain a check on the operation of the board. The monitoring is implemented using the ATMEGA64 microcontroller.

Control algorithms within the microcontroller automatically check line voltages and on board temperatures and shares the information with blockram in the Bridge FPGA.

The following voltage rails and temperatures are monitored:

Monitor	Purpose
1.0V	FPGA Core Supply (VccINT)
1.0V	Target Tranceiver Power (AVCC)
1.0V	Bridge Tranceiver Power (AVCC)
1.2V	Target Tranceiver Power (AVTT)
1.2V	Bridge Tranceiver Power (AVTT)
1.5V	DDR3 SDRAM, Target FPGA memory I/O
XRM_VIO	(Front-Panel) I/O voltage
1.8V	Target Tranceiver Power (AVCC_AUX)
1.8V	Flash Memory, FPGA IO Voltage (VCCO)
2.0V	Target FPGA Auxiliary Supply AUX (VccAUX)
2.5V	Level Translation, Bridge FPGA Auxiliary Supply (VccAUX)
3.3V	Board Input Supply
5.0V	Internally generated 5V supply
VPWR	Board Input Supply (either 5.0V or 12.0V)
Temp1	Target FPGA on-die temperature
Temp2	Board temperature sensor on-die temperature
Temp3	Bridge FPGA on-die temperature

**Table 10 : Voltage and Temperature Monitors**

An example application that reads the system monitor ("system") is available within the SDK.

### 3.7.1 Automatic Temperature Monitoring

The onboard system monitor microcontroller contains pre-programmed temperature limits. The temperature limits are shown in Table Temperature Limits:

	Target FPGA		Bridge FPGA		Board	
	Min	Max	Min	Max	Min	Max
Commercial	0 degC	+85 degC	0 degC	+85 degC	0 degC	+85 degC
Extended	0 degC	+100 degC	0 degC	+100 degC	0 degC	+100 degC
Industrial	-40 degC	+100 degC	-40 degC	+100 degC	-40 degC	+100 degC

**Table 11 : Temperature Limits**

Important:

If either FPGA temperature limit is exceeded, the Target FPGA is automatically cleared. This is indicated by the Green LED (Target Configured or DONE) switching off and the two status LEDs showing a temperature fault indication. This condition is cleared with a power cycle.

The purpose of this mechanism is to protect the card from damage due to over-temperature. It is possible that it will cause the user application and, possibly, the host computer to "hang" as a result of communication errors.

An overtemperature shutdown will not occur until the system monitor reads 5 degC above the maximum limit for multiple samples in a row (i.e. +105 degC for Industrial boards). This is to compensate for potential errors in the temperature readings. There is no protection mechanism in place for minimum temperatures or the "Board" temperature sensor limits.

### 3.7.2 Microcontroller Status LEDs

LEDs D7 (Red) and D8 (Green) indicate the microcontroller status.

LEDs	Status
Green	Running and no alarms
Green + Red	Standby (Powered off)
Flashing Green + Flashing Red (together)	Attention - critical alarm active
Flashing Green + Flashing Red (alternating)	Service Mode
Flashing Green + Red	Attention - alarm active
Red	Missing application firmware or invalid firmware
Flashing Red	FPGA configuration cleared to protect board

**Table 12 : Status LED Definitions**

## 3.8 Local Bus

A Multiplexed Packet Transport Link (MPTL) connects the Bridge and Target FPGAs. It is capable of transferring data at up to 2GB/s simultaneously in each direction.

The MPTL replaces the parallel local bus used in previous generations of the ADM-XRC series. Details of the link and example designs are given in the Software Development Kit (SDK).

## 3.9 Target FPGA

### 3.9.1 I/O Bank Voltages

The Target FPGA IO is arranged in banks, each with their own supply pins. The bank numbers, their voltage and function are shown in [Target FPGA IO Banks](#). Full details of the IOSTANDARD required for each signal are given in the SDK.

IO Banks	Voltage	Purpose
0, 14	1.8V	Configuration, JTAG, LBus Control, XMC Control, Target SelectMap Interface
13, 33	1.8V	Pn4 & Pn6 GPIO
15, 16, 17	XRM_VIO	XRM Interface (variable voltage)
18, 19, 34, 35, 36, 37, 38, 39	1.5V	DRAM Banks 0-3

Table 13 : Target FPGA IO Banks

### 3.9.2 Target MGT Links

There are a total of 26 Multi-Gigabit Transceiver (MGT) links connected to the Target FPGA:

Links	Width	Connection
PCIe(3:0)	4	Bridge FPGA (for MPTL) or XMC Connector P5 lanes (3:0) in Bridge Bypass Mode
PCIe(7:4)	4	Direct link to XMC P5 lanes (7:4)
P6(9:0)	10	Direct link to XMC P6 lanes (9:0)
FrontMGT(7:0)	8	Direct link to XRM interface

Table 14 : Target MGT Links

The connections of these links are shown in [MGT Links](#).

For MGT Clocking see [Clocks](#).

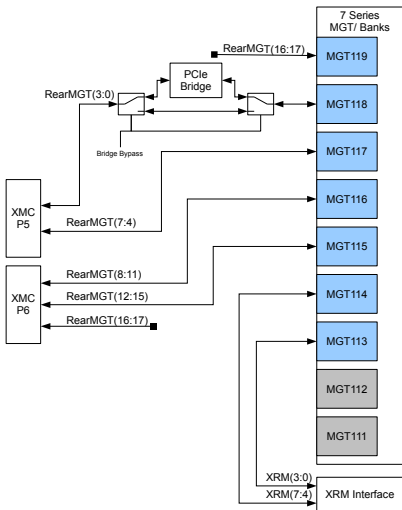


Figure 7 : MGT Links

### 3.10 Memory Interfaces

The **ADM-XRC-7V1** has four independent banks of DDR3 SDRAM. Each bank consists of two 16 bit wide memory devices in parallel to provide a 32 bit datapath capable of running up to 800MHz (DDR-1600). 2Gb devices (Micron MT41J64M16-187E) are fitted as standard to provide 512MB per bank. 4Gb (giving 1GB per bank) are available as an ordering option.

The memory banks are arranged for compatibility with the Xilinx Memory Interface Generator (MIG). **DRAM Banks** Shows the component references and FPGA banks used. Full details of the interface, signaling standards and an example design are provided in the SDK.

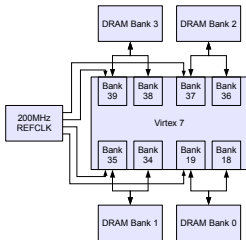


Figure 8 : DRAM Banks

FPGA Speed Grade	Single Rank (2GB-8GB)
-3	1600
-2/-2L/-2G	1600
-1	1600
-1M	1066

Table 15 : Maximum Memory Speeds

## 3.11 XRM Interface and Front-Panel I/O

The XRM interface provides a high-performance and flexible front-panel interface through a range of interchangeable XRM modules. Further details of the XRM modules can be found on the Alpha Data website.

The XRM interface consists of two samtec connectors, CN1 and CN2.

### 3.11.1 XRM Connector, CN1

Connector CN1 is for general-purpose signals, power and module control. The connector is a 180-way Samtec connector with 3 fields.

The part fitted to the **ADM-XRC-7V1** is Samtec QSH-090-01-F-D-A-K.

Full pinout information for this connector is listed in [XRM Connector CN1, Field 1](#) to [XRM Connector CN1, Field 3](#).

### 3.11.2 XRM Connector CN2

Connector CN2 is for the high-speed serial (MGT) links.

The part fitted to the **ADM-XRC-7V1** is Samtec QSE-014-01-F-D-DP-A-K.

Full pinout information for this connector is listed in [XRM Connector CN2](#).

### 3.11.3 XRM I/F - GPIO

The general purpose IO (GPIO) signals are connected in 4 groups to the Target FPGA. Each group consists of 16 standard I/O pairs, a Regional Clock Capable pair and either 2 or 4 single-ended signals. There are no on-board terminations on the pairs and any can be used in single-ended modes.

To allow fast data transfer, all of the GPIO signals within a group are delay matched to within 100ps.

All the XRM GPIO signals and FPGA IO banks share a common voltage, XRM\_VIO, that can be either 1.8V, 1.5V or 1.2V. The required voltage is stored within the platform management PROM on the XRM.

Group	FPGA Bank	Name	Function
Group A	16-17	XRM_DA (15:0)	16 diff. Pairs / 32 single-ended
		XRM_DA_CC (16)	Regional Clock / GPIO pair / 2 single-ended
		SA (1:0)	2 single-ended GPIO
Group B	15-16	XRM_DB (15:0)	16 diff. Pairs / 32 single-ended
		XRM_DB_CC (16)	Regional Clock / GPIO pair / 2 single-ended
		SB (1:0)	2 single-ended GPIO
Group C	15	XRM_DC (15:0)	16 diff. Pairs / 32 single-ended
		XRM_DC_CC (16)	Regional Clock / GPIO pair / 2 single-ended
		SC (1:0)	2 single-ended GPIO
Group D	17	XRM_DD (15:0)	16 diff. Pairs / 32 single-ended
		XRM_DD_CC (16)	Regional Clock / GPIO pair / 2 single-ended
		SD (3:0)	4 single-ended GPIO

**Table 16 : XRM GPIO Groups**



### 3.11.4 XRM I/F - High-speed Serial Links

Eight MGT links are routed between the Target FPGA and the XRM interface. Lanes (6:0) are routed through the Samtec QSE-DP connector, CN2. Lane (7) is routed through the Samtec QSH connector, CN1.

### 3.11.5 XRM IO Voltage Override

Each XRM is built with an I2C EEPROM that contains vital product information (VPD) such as part number, serial number, operating voltage, and product specific information. For designing custom XRM's, contact Alpha-Data for details on duplicating this VPD data.

Alternatively, if using an ADM-XRC-7V1 rev 4 or newer, FORCE2V5\_L can be driven low to select 1.8V for the front I/O voltage. Note that FORCE2V5\_L is a signal name from a historical design, and the operating voltage will not be 2.5V but rather 1.8V if this mode is used.

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## Appendix A: Rear Connector Pinouts

### Appendix A.1: Primary XMC Connector, P5

	A	B	C	D	E	F
1:	PET_PO	PET_NO	3V3	PET_P1	PET_N1	VPWR
2:	GND	GND	TRST_L	GND	GND	MRSTI_L
3:	PET_P2	PET_N2	3V3	PET_P3	PET_N3	VPWR
4:	GND	GND	TCK	GND	GND	MRSTO_L
5:	PET_P4	PET_N4	3V3	PET_P5	PET_N5	VPWR
6:	GND	GND	TMS	GND	GND	12V0
7:	PET_P6	PET_N6	3V3	PET_P7	PET_N7	VPWR
8:	GND	GND	TDI	GND	GND	M12V0
9:	-	-	-	-	-	VPWR
10:	GND	GND	TDO	GND	GND	GAO
11:	PER_PO	PER_NO	MBIST_L	PER_P1	PER_N1	VPWR
12:	GND	GND	GA1	GND	GND	MPRESENT_L
13:	PER_P2	PER_N2	3V3_AUX	PER_P3	PER_N3	VPWR
14:	GND	GND	GA2	GND	GND	I2C_SDA
15:	PER_P4	PER_N4	-	PER_P5	PER_N5	VPWR
16:	GND	GND	MVMRO	GND	GND	MSCL
17:	PER_P6	PER_N6	-	PER_P7	PER_N7	-
18:	GND	GND	-	GND	GND	-
19:	REFCLK0_P	REFCLK0_N	-	WAKE_L	ROOTO_L	-

Table 17 : Pn5 Interface

## Appendix A.2: Secondary XMC Connector, P6

	A	B	C	D	E	F
1:	PN6_TX_P0	PN6_TX_N0	GP37	PN6_TX_P1	PN6_TX_N1	GP38
2:	GND	GND	GP35	GND	GND	GP36
3:	PN6_TX_P2	PN6_TX_N2	GP33	PN6_TX_P3	PN6_TX_N3	GP34
4:	GND	GND	GP31	GND	GND	GP32
5:	PN6_TX_P4	PN6_TX_N4	GP29	PN6_TX_P5	PN6_TX_N5	GP30
6:	GND	GND	GP27	GND	GND	GP28
7:	PN6_TX_P6	PN6_TX_N6	GP25	PN6_TX_P7	PN6_TX_N7	GP26
8:	GND	GND	GP23	GND	GND	GP24
9:	PN6_TX_P8	PN6_TX_N8	GP21	PN6_TX_P9	PN6_TX_N9	GP22
10:	GND	GND	GP19	GND	GND	GP20
11:	PN6_RX_P0	PN6_RX_N0	GP17	PN6_RX_P1	PN6_RX_N1	GP18
12:	GND	GND	GP15	GND	GND	GP16
13:	PN6_RX_P2	PN6_RX_N2	GP13	PN6_RX_P3	PN6_RX_N3	GP14
14:	GND	GND	GP11	GND	GND	GP12
15:	PN6_RX_P4	PN6_RX_N4	GP9	PN6_RX_P5	PN6_RX_N5	GP10
16:	GND	GND	GP7	GND	GND	GP8
17:	PN6_RX_P6	PN6_RX_N6	GP5	PN6_RX_P7	PN6_RX_N7	GP6
18:	GND	GND	GP3	GND	GND	GP4
19:	PN6_RX_P8	PN6_RX_N8	GP1	PN6_RX_P9	PN6_RX_N9	GP2

Table 18 : Pn6 Interface

## Appendix A.2.1: Pn6 GPIO Pin Map

Signal	FPGA Pin	FPGA Bank
GP1	BA32	13
GP2	BA30	13
GP3	BA31	13
GP4	BB31	13
GP5	AW31	13
GP6	AY32	13
GP7	AV30	13
GP8	AY30	13
GP9	AV35	13
GP10	AR35	13
GP11	AW33	13
GP12	AV33	13
GP13	AV34	13
GP14	AY33	13
GP15	AT35	13
GP16	AW30	13
GP17	AW32	13
GP18	AV31	13
GP19	AT31	13
GP20	AU32	13
GP21	AR30	13
GP22	AU31	13
GP23	AT32	13
GP24	AN20	33
GP25	AL24	33
GP26	AR33	13
GP27	AU33	13
GP28	AT30	13
GP29	AP32	13
GP30	AP31	13
GP31	AR34	13
GP32	AR32	13
GP33	AP30	13
GP34	AP33	13

Table 19 : Pn6 GPIO Pin Map (continued on next page)

Signal	FPGA Pin	FPGA Bank
GP35	AN30	13
GP36	AL32	14
GP37	AL31	14
GP38	AN31	13

**Table 19 : Pn6 GPIO Pin Map**

GCC: Global clock capable

MRCC: Multi-region clock capable

SRCC: Single-region clock capable

## Appendix A.3: PMC Connector P4

Signal	FPGA Pin	Clock Capability	P4 Pin	P4 Pin	Clock Capability	FPGA Pin	Signal
PN4_P1	AK20	-	1	2	-	AJ21	PN4_P2
PN4_N1	AL20	-	3	4	-	AJ20	PN4_N2
PN4_P3	AJ23	-	5	6	-	AJ22	PN4_P4
PN4_N3	AK23	-	7	8	-	AK22	PN4_N4
PN4_P5	AM24	-	9	10	-	AL21	PN4_P6
PN4_N5	AN24	-	11	12	-	AM21	PN4_N6
PN4_P7	AL22	-	13	14	-	AN21	PN4_P8
PN4_N7	AM22	-	15	16	-	AP21	PN4_N8
PN4_P9	AM23	-	17	18	-	AP23	PN4_P10
PN4_N9	AN23	-	19	20	-	AP22	PN4_N10
PN4_P11	AT34*	-	21	22	SRCC	AR23	PN4_P12
PN4_N11	AU34*	-	23	24	SRCC	AR22	PN4_N12
PN4_P13	AU23	MRCC	25	26	MRCC	AT22	PN4_P14
PN4_N13	AV23	MRCC	27	28	MRCC	AU22	PN4_N14
PN4_P15	AY35*	-	29	30	-	AU24	PN4_P16
PN4_N15	AW35*	-	31	32	-	AV24	PN4_N16
PN4_P17	AT36*	-	33	34	-	AR24	PN4_P18
PN4_N17	AU36*	-	35	36	-	AT24	PN4_N18
PN4_P19	AT21	-	37	38	-	AV36*	PN4_P20
PN4_N19	AU21	-	39	40	-	AW36*	PN4_N20
PN4_P21	AY23	-	41	42	-	AV21	PN4_P22
PN4_N21	AY22	-	43	44	-	AW21	PN4_N22
PN4_P23	AY25	-	45	46	SRCC	AW23	PN4_P24
PN4_N23	BA25	-	47	48	SRCC	AW22	PN4_N24
PN4_P25	BA21	-	49	50	-	AY24	PN4_P26
PN4_N25	BB21	-	51	52	-	BA24	PN4_N26
PN4_P27	BB24	-	53	54	-	BA22	PN4_P28
PN4_N27	BB23	-	55	56	-	BB22	PN4_N28
PN4_P29	AY34*	-	57	58	-	BB32*	PN4_P30
PN4_N29	BA35*	-	59	60	-	BB33*	PN4_N30
PN4_P31	BA34*	-	61	62	-	BA36*	PN4_P32
PN4_N31	BB34*	-	63	64	-	BB36*	PN4_N32

Table 20 : Pn4 Interface

MRCC: Multi-region clock capable

SRCC: Single-region clock capable

\* For XCV550T or XCV330T pins cannot be used as LVDS

## Appendix A.4: Rear MGT Connections to the Target FPGA

In normal mode, the target FPGA RearMGT lanes (3:0) are connected to the Bridge FPGA. In Bridge Bypass Mode, they are connected to P5 lanes (3:0).

RearMGT Lanes (7:4) are connected directly to P5 lanes (7:4).

RearMGT Lanes (17:8) are connected directly to P6 lanes (9:0).

The pin mappings are as follows:

Signal	FPGA + Pin	FPGA - Pin	Rear Connector + Pin	Rear Connector - Pin
RearMGT_TX_0	J2	J1	P5.A1	P5.B1
RearMGT_TX_1	H4	H3	P5.D1	P5.E1
RearMGT_TX_2	G2	G1	P5.A3	P5.B3
RearMGT_TX_3	F4	F3	P5.D3	P5.E3
RearMGT_TX_4	K4	K3	P5.A5	P5.B5
RearMGT_TX_5	L2	L1	P5.D5	P5.E5
RearMGT_TX_6	M4	M3	P5.A7	P5.B7
RearMGT_TX_7	N2	N1	P5.D7	P5.E7
RearMGT_TX_8	P4	P3	P6.A1	P6.B1
RearMGT_TX_9	R2	R1	P6.D1	P6.E1
RearMGT_TX_10	T4	T3	P6.A3	P6.B3
RearMGT_TX_11	U2	U1	P6.D3	P6.E3
RearMGT_TX_12	W2	W1	P6.A5	P6.B5
RearMGT_TX_13	AA2	AA1	P6.D5	P6.E5
RearMGT_TX_14	AC2	AC1	P6.A7	P6.B7
RearMGT_TX_15	AE2	AE1	P6.D7	P6.E7
RearMGT_TX_16	D4	D3	P6.A9	P6.B9
RearMGT_TX_17	E2	E1	P6.D9	P6.E9
-	-	-	-	-
RearMGT_RX_0	H8	H7	P5.A11	P5.B11
RearMGT_RX_1	G6	G5	P5.D11	P5.E11
RearMGT_RX_2	F8	F7	P5.A13	P5.B13
RearMGT_RX_3	E6	E5	P5.D13	P5.E13
RearMGT_RX_4	J6	J5	P5.A15	P5.B15
RearMGT_RX_5	L6	L5	P5.D15	P5.E15
RearMGT_RX_6	N6	N5	P5.A17	P5.B17
RearMGT_RX_7	P8	P7	P5.D17	P5.E17
RearMGT_RX_8	R6*	R5*	P6.A11	P6.B11
RearMGT_RX_9	U6	U5	P6.D11	P6.E11

Table 21 : Target RearMGT Mapping (continued on next page)



Signal	FPGA + Pin	FPGA - Pin	Rear Connector + Pin	Rear Connector - Pin
RearMGT_RX_10	V4	V3	P6.A13	P6.B13
RearMGT_RX_11	W6	W5	P6.D13	P6.E13
RearMGT_RX_12	Y4	Y3	P6.A15	P6.B15
RearMGT_RX_13	AA6	AA5	P6.D15	P6.E15
RearMGT_RX_14	AB4	AB3	P6.A17	P6.B17
RearMGT_RX_15	AC6	AC5	P6.D17	P6.E17
RearMGT_RX_16	C6	C5	P6.A19	P6.B19
RearMGT_RX_17	D8	D7	P6.D19	P6.E19

**Table 21 : Target RearMGT Mapping**

\* This differential pair is connected with reverse polarity. Use the invert polarity bit of the GTX configuration to correct the polarity inversion.

## Appendix B: Front (XRM) Connector Pinouts

The XRM interface consists of two connectors: CN1 and CN2. CN1 is a 180-way Samtec QSH in 3 fields. It is for general-purpose signals, power and module control. CN2 is a 28-way Samtec QSE-DP for high-speed serial (MGT) links.

Power
JTAG & Platform Management
General Purpose I/O
Clocks
MGT Links

## Appendix B.1: XRM Connector CN1, Field 1

Signal	FPGA	Samtec	Samtec	FPGA	Signal
DA_N0	AE35	1	2	AD31	DA_N1
DA_P0	AE34	3	4	AC31	DA_P1
DA_N2	Y33	5	6	AB31	DA_P3
DA_P2	Y32	7	8	AB32	DA_N3
DA_N4	AE33	9	10	Y40	DA_N5
DA_P4	AE32	11	12	W40	DA_P5
DA_N6	AD35	13	14	AE30	DA_N7
DA_P6	AC34	15	16	AE29	DA_P7
DA_P8	AF31	17	18	Y42	DA_P9
DA_N8	AF32	19	20	AA42	DA_N9
DA_N10	AA32	21	22	AD30	DA_N11
DA_P10	AA31	23	24	AC30	DA_P11
DA_N12	AB42	25	26	Y39	DA_P13
DA_P12	AB41	27	28	AA39	DA_N13
DA_N14	AA30	29	30	AB29	DA_P15
DA_P14	AA29	31	32	AC29	DA_N15
DB_N0	AA35	33	34	AA36	DB_N1
DB_P0	AA34	35	36	Y35	DB_P1
SA_0	AK39	37	38	AD32	DA_CC_P16
3V3	-	39	40	AD33	DA_CC_N16
3V3	-	41	42	-	FORCE2V5_L
3V3	-	43	44	-	2V5
5V0	-	45	46	-	VREF
5V0	-	47	48	-	VccIO
VBATT	-	49	50	-	VccIO
12V0	-	51	52	-	VccIO
12V0	-	53	54	-	M12V0
PRESENCE_L	-	55	56	-	TDI
TCK	-	57	58	-	TRST
TMS	-	59	60	-	TDO

Table 22 : XRM Connector CN1, Field 1

## Appendix B.2: XRM Connector CN1, Field 2

Signal	FPGA	Samtec	Samtec	FPGA	Signal
DB_N2	AD37	61	62	AV41	DB_N3
DB_P2	AD36	63	64	AU41	DB_P3
DB_N4	AA37	65	66	AH36	DB_N5
DB_P4	Y37	67	68	AG36	DB_P5
DB_N6	AG34	69	70	AW42	DB_N7
DB_P6	AF34	71	72	AW41	DB_P7
DB_N8	AB37	73	74	AT41	DB_P9
DB_P8	AB36	75	76	AU42	DB_N9
DB_P10	AF35	77	78	BA40	DB_N11
DB_N10	AF36	79	80	BA39	DB_P11
DB_N12	AC36	81	82	AY42	DB_P13
DB_P12	AC35	83	84	BA42	DB_N13
DB_N14	AF37	85	86	BB41	DB_N15
DB_P14	AE37	87	88	BA41	DB_P15
DB_CC_P16	AV40	89	90	AB34	SB_1
DB_CC_N16	AW40	91	92	AU37	SC_0
SA_1	Y38	93	94	AM38	SC_1
SB_0	Y34	95	96	AL39	SD_0
DC_CC_P16	AU38	97	98	AM42	DC_N1
DC_CC_N16	AV38	99	100	AM41	DC_P1
DC_N0	AP38	101	102	AD40	DD_CC_P16
DC_P0	AN38	103	104	AD41	DD_CC_N16
SD_1	AJ42	105	106	AG37	SD_3
SD_2	AK42	107	108	AC33	GCLK_M2C_N
MGTCLK_M2C_P	AH8	109	110	AB33	GCLK_M2C_P
MGTCLK_M2C_N	AH7	111	112	-	SDA
XRM_LVDS_C-LK_N	AF40	113	114	-	SCL
XRM_LVDS_C-LK_P	AF39	115	116	-	ALERT_N
MGT_C2M_P7	AG2	117	118	AD4	MGT_M2C_P7
MGT_C2M_N7	AG1	119	120	AD3	MGT_M2C_N7

Table 23 : XRM Connector CN1, Field 2

## Appendix B.3: XRM Connector CN1, Field 3

Signal	FPGA	Samtec	Samtec	FPGA	Signal
DC_P2	AP41	121	122	AR38	DC_P3
DC_N2	AP42	123	124	AR39	DC_N3
DC_N4	BB39	125	126	AW37	DC_P5
DC_P4	BB38	127	128	AY37	DC_N5
DC_P6	AR42	129	130	AY39	DC_P7
DC_N6	AT42	131	132	AY40	DC_N7
DC_N8	AT40	133	134	AV39	DC_N9
DC_P8	AT39	135	136	AU39	DC_P9
DC_P10	AM39	137	138	AT37	DC_N11
DC_N10	AN39	139	140	AR37	DC_P11
DC_P12	AN40	141	142	AY38	DC_N13
DC_N12	AN41	143	144	AW38	DC_P13
DC_N14	AR40	145	146	AD42	DD_P1
DC_P14	AP40	147	148	AE42	DD_N1
DD_P0	AB38	149	150	BB37	DC_N15
DD_N0	AB39	151	152	BA37	DC_P15
DD_P2	AJ40	153	154	AG41	DD_N3
DD_N2	AJ41	155	156	AF41	DD_P3
DD_N4	AE38	157	158	AA41	DD_N5
DD_P4	AD38	159	160	AA40	DD_P5
DD_P6	AH40	161	162	AL42	DD_N7
DD_N6	AH41	163	164	AL41	DD_P7
DD_N8	AH39	165	166	AC41	DD_N9
DD_P8	AG39	167	168	AC40	DD_P9
DD_N10	AK38	169	170	AE40	DD_N11
DD_P10	AJ38	171	172	AE39	DD_P11
DD_N12	AL40	173	174	AG42	DD_N13
DD_P12	AK40	175	176	AF42	DD_P13
DD_N14	AC39	177	178	AH38	DD_N15
DD_P14	AC38	179	180	AG38	DD_P15

Table 24 : XRM Connector CN1, Field 3

## Appendix B.4: XRM Connector CN2

Signal	FPGA	Samtec	Samtec	FPGA	Signal
MGT_C2M_P0	AP4	1	2	AN6	MGT_M2C_P0
MGT_C2M_N0	AP3	3	4	AN5	MGT_M2C_N0
MGT_C2M_P1	AN2	5	6	AM8	MGT_M2C_P1
MGT_C2M_N1	AN1	7	8	AM7	MGT_M2C_N1
MGT_C2M_P4	AK4	9	10	AG6	MGT_M2C_P4
MGT_C2M_N4	AK3	11	12	AG5	MGT_M2C_N4
MGT_C2M_P5	AJ2	13	14	AF4	MGT_M2C_P5
MGT_C2M_N5	AJ1	15	16	AF3	MGT_M2C_N5
MGT_C2M_P2	AM4	17	18	AL6	MGT_M2C_P2
MGT_C2M_N2	AM3	19	20	AL5	MGT_M2C_N2
MGT_C2M_P3	AL2	21	22	AJ6	MGT_M2C_P3
MGT_C2M_N3	AL1	23	24	AJ5	MGT_M2C_N3
MGT_C2M_P6	AH4	25	26	AE6	MGT_M2C_P6
MGT_C2M_N6	AH3	27	28	AE5	MGT_M2C_N6

Table 25 : XRM Connector CN2

## Revision History

Date	Revision	Changed By	Nature of Change
21 Mar 2012	0.1	K. Roth	Initial Draft
10 Aug 2012	1.0	K. Roth	Initial Release
17 Aug 2012	1.1	K. Roth	Added note to PN4 Appendix regarding LVDS, fixed P6 pinout table
22 Oct 2012	1.2	K. Roth	Updated <a href="#">Bridge-Less Mode</a> to not include revision 2 and earlier. Changed numbers in <a href="#">Memory Interfaces</a> . Fixed Figure MGT Links. Fixed notes in <a href="#">Rear MGT Connections to the Target FPGA</a> .
15 May 2013	1.3	K. Roth	Updated <a href="#">Rear MGT Connections to the Target FPGA</a> with note about polarity inversion.
6 Feb 2014	1.4	K. Roth	Updated <a href="#">JTAG Interface</a> to correctly reference SW1-5. Correct clock pin connections for DRAMs in <a href="#">REFCLK200M Connections</a> .
8 July 2014	1.5	K. Roth	Updated <a href="#">Automatic Temperature Monitoring</a> to increase uC threshold and added <a href="#">Maximum Memory Speeds</a> .
6 Feb 2015	1.5	K. Roth	Updated <a href="#">JTAG Interface</a> to use appropriate JTAG reference designator.
6 Feb 2015	1.6	K. Roth	Updated <a href="#">JTAG Interface</a> to use appropriate JTAG reference designator.
4 May 2015	1.7	K. Roth	Added <a href="#">XRM IO Voltage Override</a>
23 Aug 2016	1.8	K. Roth	Corrected MVMRO signal discription and LED figure <a href="#">LED Definitions</a> and <a href="#">MVMRO</a> . Removed references to 8G dual rank memory components as micron has consolidated to a single die ( <a href="#">Memory Interfaces</a> ).
6 Jun 2021	1.9	K. Roth	Corrected <a href="#">Automatic Temperature Monitoring</a> to remove reference to LM87, clarify trigger conditions, and add note about temperature limits.